

MRO  
6-9-99

06-21-1999

Docket No. JCLA4480



Form 1595  
1-31-92

RECORDATION

101071458

Department of Commerce  
Patent and Trademark Office

**PATENTS ONLY**

JC135 US PTO  
09/328967  
06/09/99

To the Honorable Assistant Commissioner for Patents: Please record the attached  
original documents or copy thereof.

1. Name of conveying party(ies):

Chung-Po Hsu  
Ming-Chi Lin

2. Name/address of receiving  
Party(ies):

United Semiconductor Corp.

No 3, Li-Hsin Rd. II, Science-Based  
Industrial Park, Hsinchu, Taiwan, R.O.C.

3. Nature of conveyance: ☒ Assignment  
☐ Merger ☐ Security Agreement ☐ Other  
☐ Change of Name ☐ Reassignment

Add'l names of receiving parties  
Attached? ☐ Yes ☒ No

4. Date(s) of execution: April 29, 1999

5. Application number(s) or patent number(s):

5. **If this documents is being filed together with a new application, the  
execution date of the application is April 29, 1999**

A. Patent Application No. (s)

B. Patent No. ( s)

Additional numbers attached ? ☐ Yes ☒ No

6. Name and address of party to whom  
correspondence concerning document  
should be mailed:

J.C. Patents, Inc.  
1340 Reynolds Ave., Suite 114  
Irvine, CA 92614  
(949) 660-0761

7. Total No. of applications and patents  
involved:

ONE(1)

8. Total fee (37 CFR §3.41): \$40.00

☒ Enclosed

☐ Charge to Acct. No. \_\_\_\_\_

9. Total number of pages, including  
cover sheet, attachments and document 3.

DO NOT USE THIS SPACE

10. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true  
and correct and any attached copy is a true copy of the original document.

Jiawei Huang

Name of Person Signing

Jiawei Huang  
Signature

6/9/99  
Date

Registration No. 43, 330

06/18/1999 DNGUYEN 00000053 09328967

01 FC:581

40.00 DP

**PATENT**  
**REEL: 010029 FRAME: 0808**

# ASSIGNMENT

WHEREAS,

1. Chung-Po Hsu

2. Ming-Chi Lin

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **METHOD OF FABRICATING SEMICONDUCTOR DEVICE**

[ ] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Semiconductor Corp.

of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

# ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature:

*Chung-Po Hsu*

Date:

*Apr. 29, 1999*

Sole or First Joint Inventor: Chung-Po Hsu

Signature:

*Ming-chi Lin*

Date:

*Apr. 29, 1999*

Second Joint Inventor (if any): Ming-Chi Lin